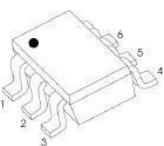


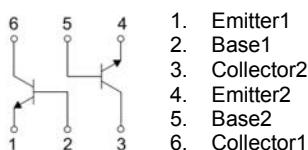
SOT-363 贴片塑封三极管

SOT-363 Plastic-Encapsulate Transistors

SOT-363



Marking: 1B



特征 Features

- 一个封装体内集成两个晶体管; Two Transistors in One Package
- 最大功率耗散 380mW; Power Dissipation of 380mW
- 高稳定性和可靠性。High Stability and High Reliability

机械数据 Mechanical Data

- 封装: SOT-363 封装SOT-363 Small Outline Plastic Package
- 环氧树脂UL 易燃等级Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

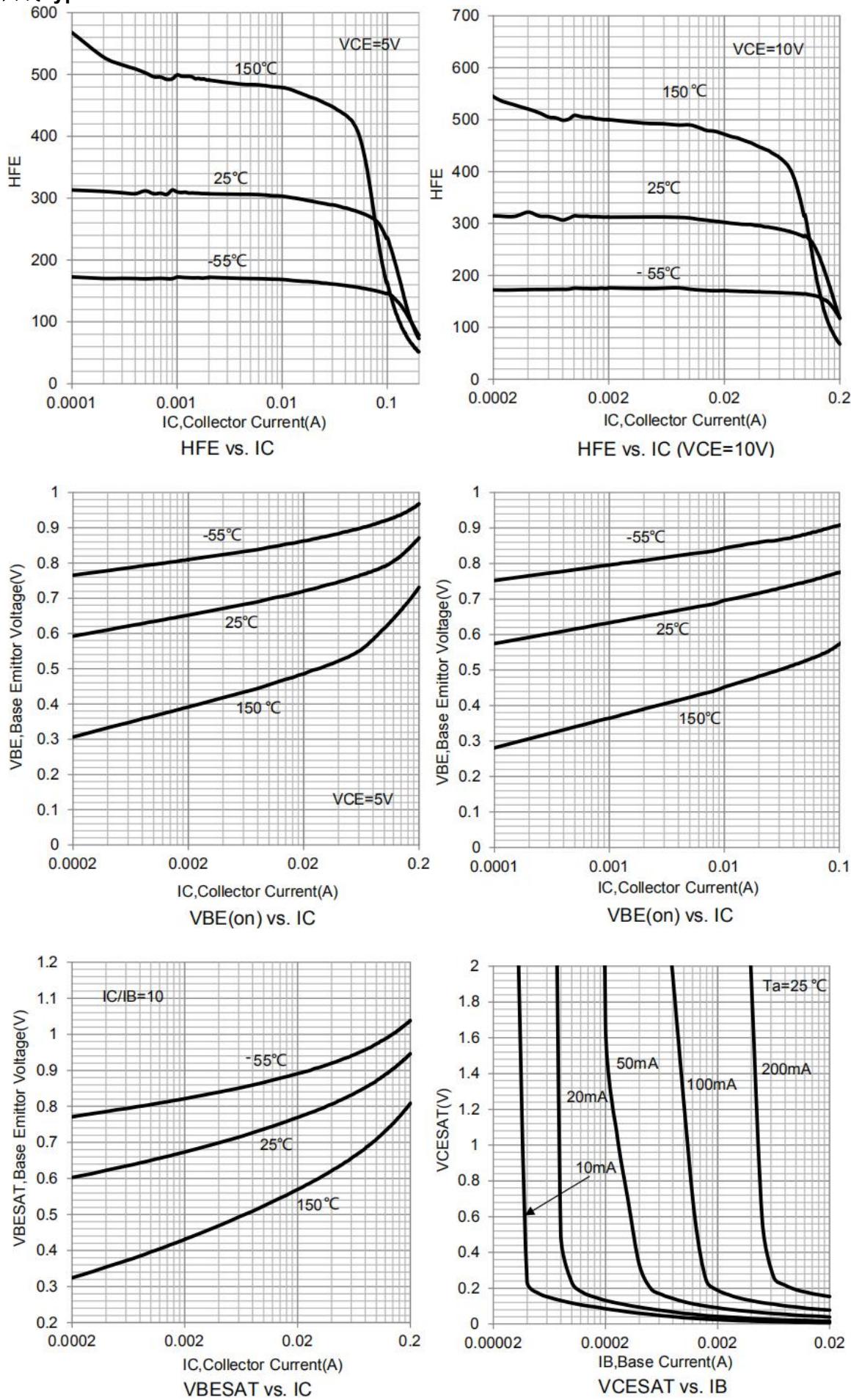
极限值和温度特性($TA = 25^\circ\text{C}$ 除非另有规定)**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
Collector-Base Voltage	V_{CBO}	80	V
Collector-Emitter Voltage	V_{CEO}	65	V
Emitter -Base Voltage	V_{EBO}	6	V
Collector Current-Continuous	I_C	100	mA
Collector Power Dissipation	P_C	380	mW
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~+150	$^\circ\text{C}$
Thermal resistance From junction to ambient	$R_{\theta JA}$	328	$^\circ\text{C}/\text{W}$

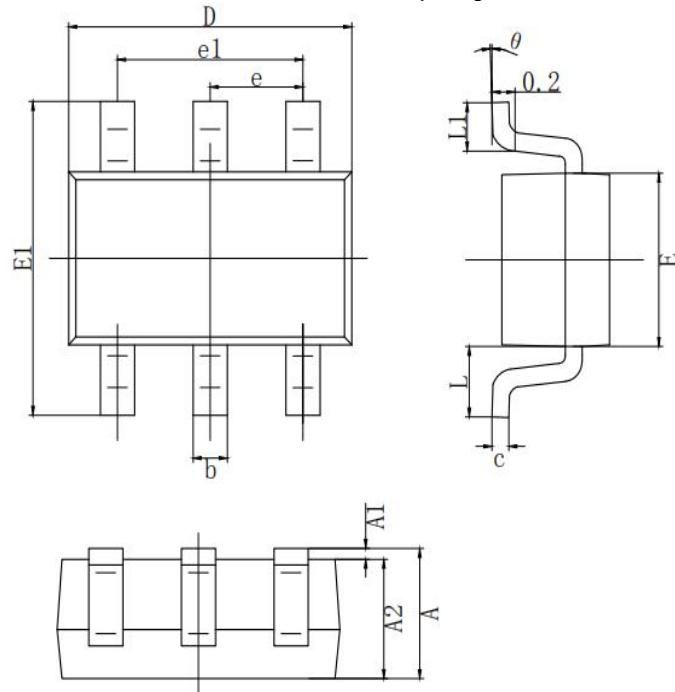
电特性 ($TA = 25^\circ\text{C}$ 除非另有规定)**Electrical Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified).

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=10\mu\text{A}, I_E=0$	80			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=10\text{mA}, I_B=0$	65			V
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$I_C=10\mu\text{A}, V_{EB}=0$	80			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=1\mu\text{A}, I_C=0$	6			V
Collector cut-off current	I_{CBO}	$V_{CB}=30\text{V}, I_E=0$			15	nA
DC current gain	h_{FE}	$V_{CE}=5\text{V}, I_C=2\text{mA}$	200		450	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C=10\text{mA}, I_B=0.5\text{mA}$			0.25	V
		$I_C=100\text{mA}, I_B=5\text{mA}$			0.6	V
Base-Emitter Saturation Voltage	$V_{BE(\text{sat})}$	$I_C=10\text{mA}, I_B=0.5\text{mA}$		0.7		V
		$I_C=100\text{mA}, I_B=5\text{mA}$		0.9		V
Base-emitter voltage	V_{BEON}	$V_{CE}=5\text{V}, I_C=2\text{mA}$	0.58		0.7	V
		$V_{CE}=5\text{V}, I_C=10\text{mA}$			0.77	V
Output Capacitance	C_{obo}	$V_{CB}=10\text{V}, f=1\text{MHz}, I_E=0$			4.5	pF
Current Gain-Bandwidth product	f_T	$V_{CE}=5\text{V}, I_C=10\text{mA}, f=100\text{MHz}$	100			MHz

典型特性曲线 Typical Characteristics Curve



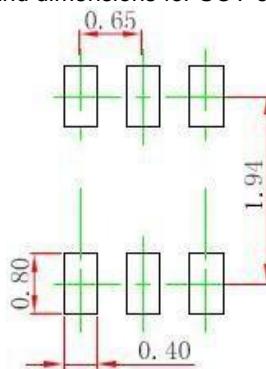
SOT-363 PACKAGE OUTLINE Plastic surface mounted package



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.900	1.100
A1	0.000	0.100
A2	0.900	1.000
b	0.150	0.350
c	0.080	0.150
D	2.000	2.200
E	1.150	1.350
E1	2.150	2.450
e	0.650 TYP.	
e1	1.200	1.400
L	0.525 REF.	
L1	0.260	0.460
θ	0°	8°

焊盘设计参考 Precautions: PCB Design

Recommended land dimensions for SOT-363. Electrode patterns for PCBs



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.